## Product Description

The Stanford Microdevices' SRM-1016 is a high linearity active mixer for use in a wide variety of communication systems covering the $800-1000 \mathrm{MHz}$ frequency bands. This device operates from a single 5 V supply and provides 10 dB of conversion gain while requiring only 0 dBm input to the integrated LO driver. The SRM-1016 also includes an integrated on chip IF amplifier and is fabricated using silicon germanium device technology.

The SRM-1016 incorporates internal matching on each RF, IF, and LO port to enhance ease of use and to reduce the number of external components required. The RF and LO ports can be driven differential or single ended. Each broadband port has been designed to minimize performance degradation while operating into highly reactive components such as SAW filters.


## SRM-1016

## 800-1000 MHz High Linearity

 Silicon Germanium Active Receive Mixer

16 pin TSSOP with Exposed Pad
Package Body: $0.20 \times 0.17 \times 0.04$ (inches) $5.0 \times 4.4 \times 1.0(\mathrm{~mm})$

## Product Features

- Active mixer with conversion gain
- No need for separate external LO driver
- Low LO drive level required to drive mixer
- RF and LO ports may be driven differentially
- Single supply operation (+5V)
- Broadband resistive $50 \Omega$ impedances on all three ports


## Applications

- Digital and spread spectrum communication systems
- 800-1000 MHz transceivers for base station infrastructure equipment


## Key Specifications

| Parameters | Test Conditions (VCC=5.0V, I=150mA, T=25C) | Unit | Min. | Typ. | Max. |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Frequency Range |  | MHz | 800 |  | 1000 |
| IF Frequency Range |  | MHz | 10 | 200 | 300 |
| Input IP3 | RF1 = RF2 $=-17 \mathrm{dBm} / t o n e$ | dBm |  | +20 |  |
| Input P1dB |  | dBm |  | +5 |  |
| Conversion Gain |  | dB |  | 10 |  |
| SSB Noise Figure |  | dB |  | 15 |  |

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## Absolute Maximum Ratings

| Parameters | Value | Unit |
| :--- | :---: | :---: |
| Supply Voltage | +6.0 | $\mathrm{~V}_{\mathrm{DC}}$ |
| LO Input | +10 | dBm |
| RF Input | +15 | dBm |
| Operating Temperature | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |

## Test Conditions

| VCC | +5.0 V |
| :--- | :--- |
| TA | $+25 \div \mathrm{C}$ |
| RF Input | $-20 \mathrm{dBm} @ 900 \mathrm{MHz}$ |
| LO Input | $0.7 \mathrm{dBm} @ 700 \mathrm{MHz}$ |

Product Specifications - AC Performance

| Parameters | Additional Test Conditions | Unit | Min. | Typ. | Max. |
| :--- | :--- | :---: | :---: | :---: | :---: |
| Frequency Range |  | MHz | 800 |  | 1000 |
| IF Frequency Range |  | $\mathrm{MF} 1=\mathrm{RF} 2=-17 \mathrm{dBm} /$ tone | MHz | 10 | 200 |
| Input IP3 |  | dBm |  | +20 |  |
| Input P1dB |  | dBm |  | +5 |  |
| Conversion Gain |  | dB |  | 10 |  |
| SSB Noise figure |  | dB |  | 15 |  |
| RF Return Loss |  | dB |  | 14 |  |
| LO Return Loss |  | dB |  | 14 |  |
| IF Return Loss |  | dB |  | 14 |  |
| LO Drive |  | dBm | -3 | 0 | +3 |

Product Specifications - Isolation Performance

| Parameters | Additional Test Conditions | Unit | Min. | Typ. | Max. |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| Leakage (LO-RF) |  | dBm |  | -40 |  |
| Leakage (LO-IF) |  | dBm |  | -26 |  |

Product Specifications - Miscellaneous

| Parameters | Additional Test Conditions | Unit | Min. | Typ. | Max. |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage |  | V | +4.75 | +5.0 | +5.25 |
| Supply Current |  | mA |  | 150 |  |
| Thermal Resistance |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |  | TBD |  |

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## Typical Device Performance



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Pin Out Description

| Pin \# Description |  | Additional Comments |  |
| :---: | :---: | :--- | :--- |
| 1 | IFP | IF output, positive terminal | Nominal DC voltage is 1.6V. Output should be AC-coupled |
| 2 | VCC | Positive supply ( +5 V ) |  |
| 3 | VEE | Ground | Nominal DC voltage is 2.1V. (Internally biased) Input should be AC- <br> coupled. |
| 4 | RFP | RF input, positive terminal | Nominal DC voltage is 2.1V. (Internally biased) Input should be AC- <br> coupled. |
| 5 | RFN | RF input, negative terminal |  |
| 6 | VEE | Ground | Nominal DC voltage is 5V, provided through off chip inductors. |
| 7 | VCC | Positive supply (+5V) | Nominal DC voltage is 5V, provided through off chip inductors. |
| 8 | L1 | External inductor terminal | Nominal DC voltage is 2.4V. (Internally biased) Input should be AC- <br> coupled. |
| 9 | L2 | External inductor terminal | Nominal DC voltage is 2.4V. (Internally biased) Input should be AC- <br> coupled. |
| 10 | VCC | Positive supply (+5V) |  |
| 11 | VEE | Ground | LO input, negative terminal |
| 12 | LON | LOP | LO input, positive terminal |
| 14 | VEE | Ground | Positive supply (+5V) |
| 15 | VCC | IFN | Nominal DC voltage is 1.6V. Output should be AC-coupled. |
| 16 | IF output, negative terminal |  |  |

## Caution: ESD Sensitive

Appropriate precaution in handling, packaging and testing devices must be observed.

## Part Number Ordering Information

| Part Number | Reel Size | Devices/Reel |
| :---: | :---: | :---: |
| SRM-1016 | TBD | TBD |

## Part Symbolization

The part will be symbolized with a "TBD" marking designator on the top surface of the package.

## Package Dimensions ("16" Package)



NOTE

1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS
. TOLERANCE $\pm 0.1 \mathrm{~mm}$ UNLESS OTHERWISE SPECIFIED
. COPLANARITY : 0.1 mm
2. CONTROLLING DIMENSION IS MILLIMETER. CONVERTED

INCH DIMENSIONS ARE NOT NECESSARILY EXACT
5. FOLLOWED FROM JEDEC MO-153

| SYMBOLS | DIMENSIONS IN MILLIMETERS |  |  |  | DIMENIINS ININCHES |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | NOM | MAX | MIN | NOM | MAX |  |
| A | - | -- | 1.15 | -- | --- | 0.045 |  |
| A1 | 0.00 | - | - | 0.10 | 0.000 | -- | 0.004 |
| A2 | 0.80 | 1.00 | 1.05 | 0.031 | 0.039 | 0.041 |  |
| b | 0.19 | - | 0.30 | 0.007 | -- | 0.012 |  |
| C | 0.09 | -- | 0.20 | 0.004 | --- | 0.008 |  |
| D | 4.90 | 5.00 | 5.10 | 0.193 | 0.197 | 0.201 |  |
| D1 | - | 2.80 | - | -- | 0.110 | -- |  |
| E | - | 6.40 | - | - | 0.252 | - |  |
| E1 | 4.30 | 4.40 | 4.50 | 0.169 | 0.173 | 0.177 |  |
| E2 | - | 2.80 | - | - | 0.110 | - |  |
| e | - | 0.65 | - | - | 0.026 | - |  |
| L | 0.45 | 0.60 | 0.75 | 0.018 | 0.024 | 0.030 |  |
| y | - | - | 0.10 | - | - | 0.004 |  |
| $\theta$ | $0^{\circ}$ | - | 8 | $0^{\circ}$ | -- | $8^{\circ}$ |  |
|  |  |  |  |  |  |  |  |

## Test PCB Pad Layout



## Demo Test Board Schematic



Bill of Materials

| Component <br> Designator |  | Value | Vendor | Part Number |  |
| :---: | :---: | :---: | :--- | :--- | :--- |
| A10 |  | 1 | SMDI | SRM-1016 | SiGe Receive Mixer |
| A7, A8, A12 |  | 3 | Johnson <br> Components | $142-0701-851$ | SMA connector, end launch with tab, for 62 mil <br> thick board |
| CON |  | 1 | Digikey | S1212-36-ND | 2-pin header |
| A2 | $1: 1$ | 1 | Mini-Circuits | TC1-1 | IF transformer |
| Lfil | 1 uH | 1 | Digikey | PCD1008CT-ND | Inductor, 1210 footprint, min. 200mA rating |
| C1, C3, C20, C21 | $27 p F$ | 4 | Venkel | C0603COG500-270JNE | Capacitor, 0603 footprint |
| C6, C10 | 100 pF | 2 | Venkel | C0603COG500-101JNE | Capacitor, 0603 footprint |
| C7, C9 | 120 pF | 2 | Venkel | C0603COG500-121JNE | Capacitor, 0603 footprint |
| C4, C5 | $33 p F$ | 2 | Venkel | C0805COG500-330JNE | Capacitor, 0603 footprint |
| C11, C12 | $39 p F$ | 2 | Venkel | C0805COG500-390JNE | Capacitor, 0603 footprint |
| L1, L2 | 100 nH | 2 | TOKO | LL1608-FSR10J | Inductor, 0603 footprint, high Q series |
| R1, R2, R3, R4 | 0 ohm | 4 | Venkel | CR0603-16W-000T | Resistor, 0603 footprint |

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## Demo Test Board (Fully Assembled PCB)



Note: Dimensions in inches
Standard test board set up for IF $=200 \mathrm{MHz}$


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